

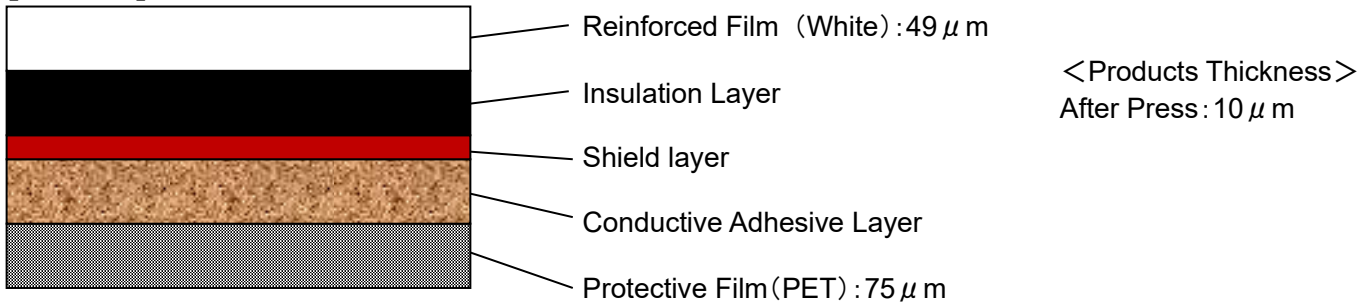
LIOELM® TSS500Z K2

【Characteristics】

This Electromagnetic Wave Shield Film is designed for high-speed transmission circuit. TSS500Z K2 has an excellent flexibility / excellent electrical conductivity / excellent humidity resistance.

TSS500Z K2 is advanced EMI shielding film for next generation high-speed transmission devices. Our product offers transmission loss decrease.

【Structure】



【Technical Data】

Product name	TSS500Z K2
Reinforced film	49um PET
Insulation layer	Modified urethane resin based 4 $\pm$ 2 μ m
Shield layer	Metal layer 2 μ m
Conductive adhesive layer	Modified urethane resin based 4 $\pm$ 2 μ m
Protective film	75um PET
Thickness of Shield layer	11 $\pm$ 4 μ m
Thickness of Shield layer	10 $\pm$ 3 μ m
Shielding Effect	More than 80dB (1GHz)
Surface resistance	Less than 50m Ω / $\square$
Peel Strength (PI)	More than 3N/cm

Above data is our self-conducted test result but not our guaranteed performance.

<Peel strength measurement conditions>

1. Structure: Kapton200H/(Conductive layer Side)TSS(Insulation layer Side)/Adhesive sheet/Kapton200EN
2. Laminating conditions: Laminate 90°C→Press 150~160°C-2MPa-30min
3. Peel speed : 50mm/min
4. Peel angle:90°

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【How to apply (Quick Press)】

- 1) Release Protect film from conductive layer
- 2) Laminating on FPC (Tentative Fastening)
- 3) Heat Press on Insulation layer side with Transfer film under vacuum condition more than 3 min to avoid void.
- 4) Release Transfer film
- 5) Post Cure

【How to apply (Only Press)】

- 1) Release Protect film from conductive layer
- 2) Laminating on FPC with roll laminator(Tentative Fastening)
- 3) Heat Press on Insulation layer side with Transfer film over 30 min.
Vacuum press is recommended to avoid void.
- 4) Release Transfer film

【Recommended Press Condition】

	Press condition			Post Cure	
	Temp	Press	Time	Temp	Time
Quick Press & PostCure	150~160℃	2~3MPa	More than 3min	150~160℃	More than 1h
Only Press	150~160℃	2~3MPa	More than 60min	-	-

Note:Please decide the press condition after you evaluate in advance.

【Notice of Storage Condition】

- ☐ TSS500Z K2 should be stored under 10℃ / 70%RH.
- ☐ Please leave the shield film stored under refrigerating condition at room temperature for adequate time
- ☐ Recommended restoration time is more than 7 hours
- ☐ If it takes time from cutting process to heat process, please keep them under a refrigerating storage

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